## Talent shortage - Gender imbalance - Public defiance towards technology... Can science help us?

Patrick COGEZ, AENEAS Christopher FRIELING, SEMI Europe Suzanne LESECQ, CEA-LETI Ina SEBASTIAN, Infineon Technologies AG Dimitrios SERPANOS, University of Patras



Organised by: AENEAS, EPoSS & Inside

## Promising Technologies for ECS (Sept 22nd, 2022 Online Workshop)



- SRIA Long Term Vision Chapter Update
- Exploration of promising technologies with high potential
  - Three topics identified
    - Artificial Intelligence for Safety Critical Systems
    - 2D Materials for Future Heterogeneous Electronics
    - Roadmap Towards Sustainable Electronics
  - Similar structure: Overall presentation followed by panel discussion
  - Goals
    - Provide inputs for the LTV chapter evolution
    - Offering options / insights to the community regarding potential focus topics
- CHIPS Act Capacity Building Stream Pilot Lines
  - Presentation by the EC
  - Panel with EC and RTO representatives

# Artificial Intelligence for Safety Critical Systems

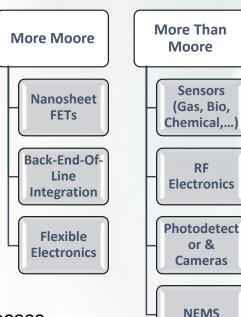


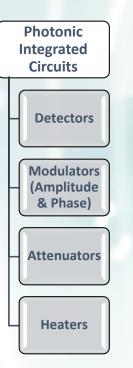
- Need to pave the way towards the development and certification of Al-based safety systems
  - Need for AI safety standard(s) definition and consolidation, complementary with functional safety standards.
  - Many ML technical challenges: training data coverage (e.g., corner cases), understandability, testability, verifiability, etc.
  - Evolution of HPC challenges (HW / SW): integration of functions of different criticality in a HPC safe execution platform:
    - Safety compliance of ML libraries and parallel programming languages.
    - Temporal and spatial independence.
    - Thermal and energy requirements.
  - Trustworthiness: Engineering, Ethics and Legal
  - Safe and secure update of systems

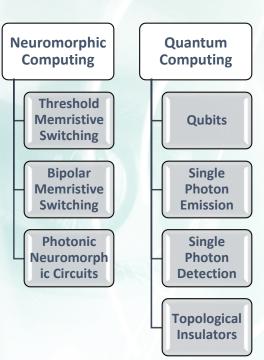
#### 2D Materials for Future Heterogeneous Electronics



Opportunities







Challenges

- Growth
- Transfer process
- Etching
- Encapsulation
- Electrical contacts

## Roadmap Towards Sustainable Electronics



- Motivation for sustainability in electronics manufacturing
  - Global electronic waste doubling within 16 years, only 20% collected/recycled properly
- Required changes of paradigms
  - Materials From fossil-based, rare to bio-based, renewable, abundant
  - Manufacturing From etching-based processes to additive manufacturing
    - Printed and hybrid electronics
  - End-of-life management From e-waste to circular economy
  - Design from designing only for performance and cost to designing also for circularity, durability, and energy-efficiency
- An on-going revolution

#### **Pilot Lines**



- RTO expectations towards pilot lines
  - Opportunity to transition better and faster from basic research to production
  - Build on the strengths (HW and design) to move fast
  - Developing skills in RTO and academia close to industry needs
- Adequation between pilot line mechanism and identified topics
  - Al for safety critical systems Holistic approach required for test and reliability
  - 2D materials
    - Need to select topics mature enough for pilot lines
    - Size of infrastructure needs varies widely across the 2D technology spectrum
  - Sustainable electronics Pilot line could help to move from etching to printing
- Governance
  - Establish plans for industrialisation from day 1
  - Avoid to have only short term objectives
  - Ensure engagement of every stakeholder, connect to all players
  - Embed flexibility, allow for redefinition of objectives

### ECS in Europe – Moving forward



- Large ambitions
- Technical challenges and opportunities
- Financial challenges and opportunities
- Non-technical challenges
  - Where do we find the people?
  - How do we ensure public acceptance of technology?

# Talent shortage - Gender imbalance - Public defiance towards technology ... Can science help us?





Christopher FRIELING, SEMI Europe



Suzanne LESECQ, CEA-LETI



Ina SEBASTIAN
Infineon Technologies AG



Dimitrios SERPANOS, University of Patras